COMPLIANT

HALOGEN

FREE



Vishay General Semiconductor

Dual Common Cathode Ultrafast Rectifier



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS								
I _{F(AV)}	30 A							
V _{RRM}	50 V, 100 V, 150 V, 200 V, 300 V, 400 V, 500 V, 600 V							
I _{FSM}	300 A							
t _{rr}	35 ns, 50 ns							
V _F at I _F = 15 A	0.95 V, 1.3 V, 1.5 V							
T _J max.	150 °C							
Package	TO-247AD 3L							
Circuit configuration	Common cathode							

FEATURES

- Power pack
- Glass passivated pellet chip junction
- · Ultrafast recovery time
- · Low switching losses, high efficiency
- Low thermal resistance
- · High forward surge capability
- Solder dip 260 °C, 40 s
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency rectifier of switching mode power supplies, inverters, freewheeling diodes, DC/DC converters, and other power switching application.

MECHANICAL DATA

Case: TO-247AD 3L

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - RoHS-compliant, halogen-free,

commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

Polarity: as marked

Mounting Torque: 10 in-lbs maximum

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)										
PARAMETER	SYMBOL	FEP 30AP	FEP 30BP	FEP 30CP	FEP 30DP	FEP 30FP	FEP 30GP	FEP 30HP	FEP 30JP	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	500	600	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	350	420	V
Maximum DC blocking voltage V _{DC}		50	100	150	200	300	400	500	600	V
Maximum average forward rectified current at $T_C = 100^{\circ}\text{C}$	I _{F(AV)}	30				Α				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	300				Α				
Operating storage and temperature range	T _J , T _{STG}	-55 to +150						°C/W		



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)											
PARAMETER	TEST CONDITIONS	SYMBOL	FEP 30AP	FEP 30BP	FEP 30CP	FEP 30DP	FEP 30FP	FEP 30GP	FEP 30HP	FEP 30JP	UNIT
Maximum instantaneous forward voltage per diode	15.0 A	V _F	0.95				1.3 1.5		.5	V	
Maximum DC reverse current at	T _C = 25 °C	10									
rated DC blocking voltage per diode	T _C = 100 °C	IR	500							μΑ	
Maximum reverse recovery time per diode	$I_F = 0.5 A,$ $I_R = 1.0 A,$ $I_{rr} = 0.25 A$	t _{rr}	35				50			ns	
Typical junction capacitance per diode	4.0 V, 1 MHz	CJ	175 145					pF			

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)									
PARAMETER	PARAMETER SYMBOL FEP 70							UNIT	
Typical thermal resistance per diode	R ₀ JC ⁽¹⁾ 1.0 °C						°C/W		

Note

⁽¹⁾ Thermal resistance from junction to case per diode mounted on heatsink

ORDERING INFORMATION (Example)									
PACKAGE	PACKAGE PREFERRED P/N UNIT WEIGHT (g) PACKAGE CODE BASE QUANTITY DELIVERY MODE								
TO-247AD 3L	FEP30JP-M3/P	5.83	Р	25/tube	Tube				



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

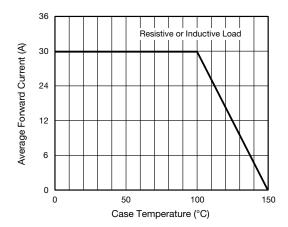


Fig. 1 - Forward Current Derating Curve

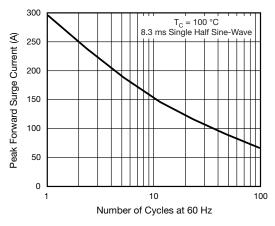


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

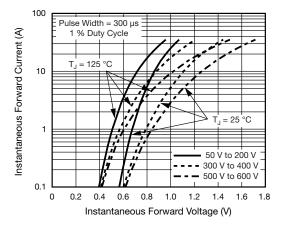


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

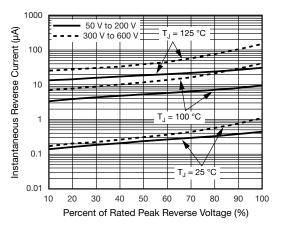


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

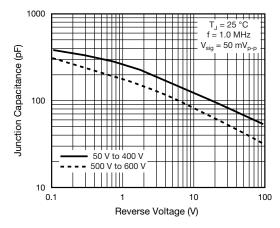
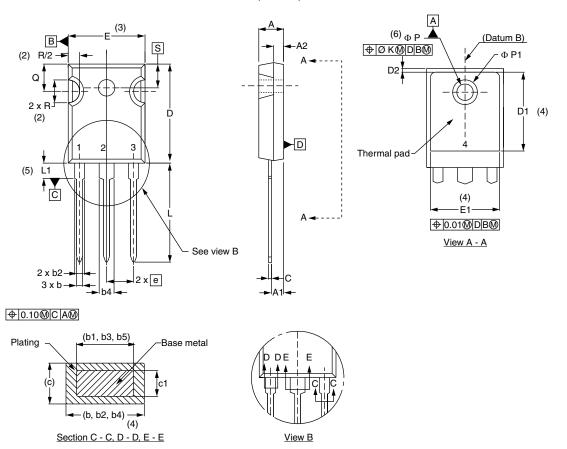


Fig. 5 - Typical Junction Capacitance Per Diode



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PACKAGE OUTLINE DIMENSIONS in millimeters (inches) TO-247AD 3L



SYMBOL	MILLIN	IETERS	INCHES		NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	IETERS	INC	NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215		
ØК	0.2	254	0.010		
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51	BSC	0.217	BSC	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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